

# LNJ216C8ARU

## Surface Mounting Chip LED

MicroLens FD Type

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter                     | Symbol    | Rating      | Unit             |
|-------------------------------|-----------|-------------|------------------|
| Power dissipation             | $P_D$     | 60          | mW               |
| Forward current               | $I_F$     | 20          | mA               |
| Pulse forward current *       | $I_{FP}$  | 100         | mA               |
| Reverse voltage               | $V_R$     | 3           | V                |
| Operating ambient temperature | $T_{opr}$ | -30 to +85  | $^\circ\text{C}$ |
| Storage temperature           | $T_{stg}$ | -40 to +100 | $^\circ\text{C}$ |

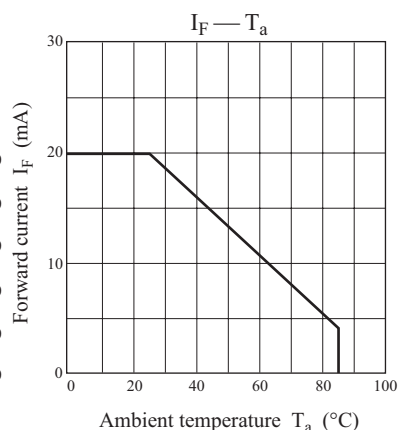
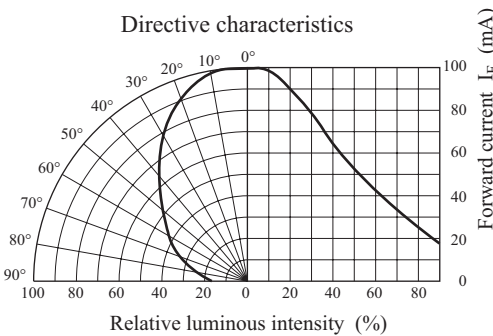
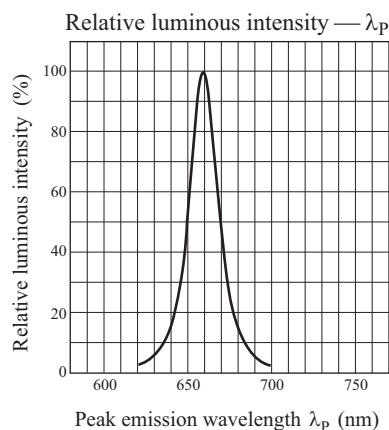
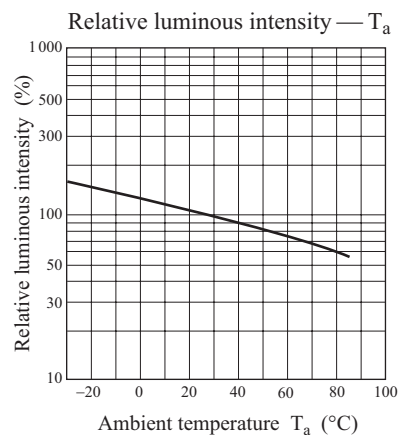
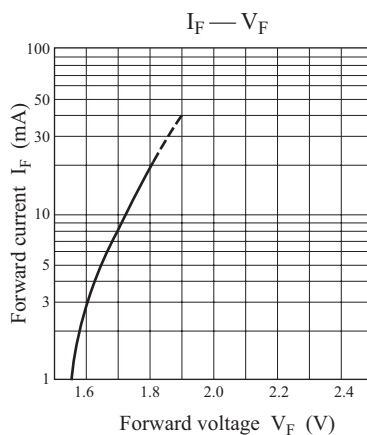
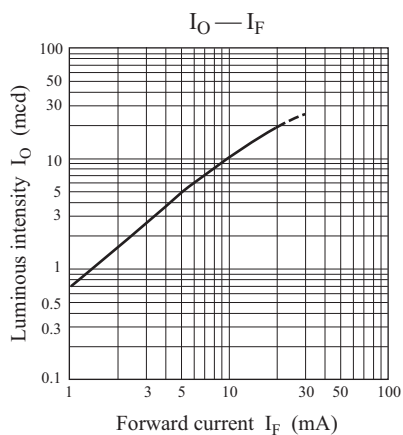
### ■ Lighting Color

- Red

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

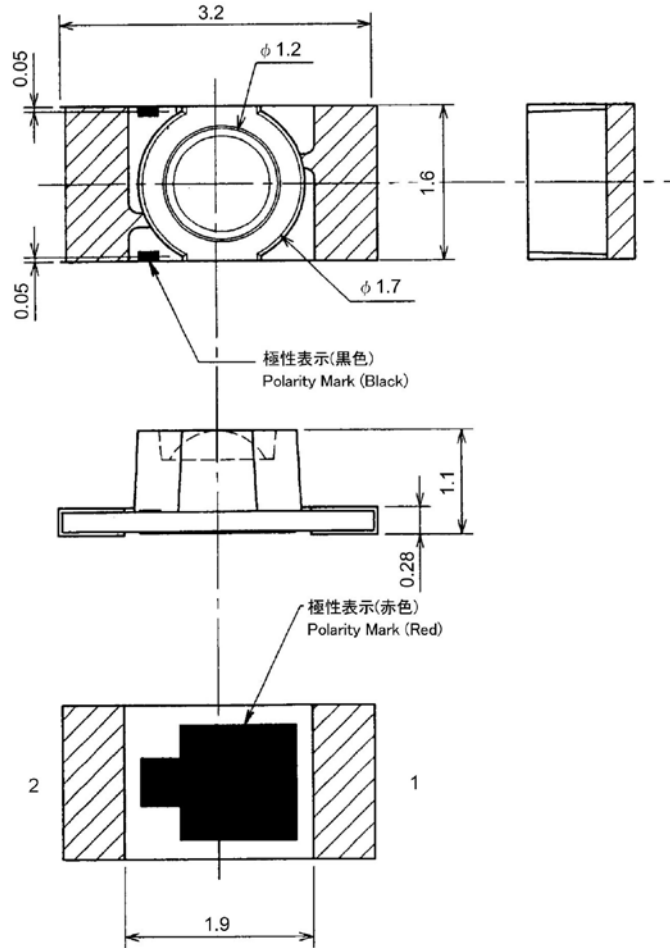
### ■ Electro-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

| Parameter                | Symbol          | Conditions           | Min | Typ  | Max  | Unit          |
|--------------------------|-----------------|----------------------|-----|------|------|---------------|
| Luminous intensity       | $I_O$           | $I_F = 10\text{ mA}$ | 4.0 | 10.5 |      | mcd           |
| Reverse current          | $I_R$           | $V_R = 3\text{ V}$   |     |      | 100  | $\mu\text{A}$ |
| Forward voltage          | $V_F$           | $I_F = 10\text{ mA}$ |     | 1.72 | 2.50 | V             |
| Peak emission wavelength | $\lambda_p$     | $I_F = 10\text{ mA}$ |     | 660  |      | nm            |
| Spectral half band width | $\Delta\lambda$ | $I_F = 10\text{ mA}$ |     | 20   |      | nm            |



■ Package (Unit: mm)

KLTLTN2K1600



- Pin name
- 1: Anode
- 2: Cathode

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